EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	2	"US 20070209762"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2010/02/01 12:05
S2	2	"US 20070184178"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2010/03/12 20:22
S3	1708	(118/52).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:33
S4	563	(118/666).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:33
S5	748	(118/313).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:33
S6	1881	(118/323).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:33
S7	341	(118/667).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:40
S8	2	((("20010009452") or ("6384894")).PN.	US-PGPUB; USPAT	OR	OFF	2010/03/12 20:45

S9	1100	(396/626).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:53
S10	449	(396/611).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:53
S11	495	(396/627).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/03/12 20:53
S12	19	("4410562" | "4633804" | "5753415" | "5830623" | "5854953" | "5893004" | "5919520" | "6230722").PN. OR ("6384894").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/03/12 21:13
S13	27	("5020200" | "5374312" | "5625433" | "5815762" | "5845170" | "5954877" | "6033475" | "6113695" | "6183810" | "6210050" | "6267516" | "6283107" | "6284043" | "6364547" | "6382849" | "6384894" | "6394111" | "6458208" | "6616762").PN. OR ("6770424").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/03/13 15:16
S14	3	2002-105176	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 15:47
S15	6	2002-303752	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 15:48

S16	9	(damper with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 19:27
S17	276	(peltier) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 19:27
S18	2	(damper with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer) and ("118"/$.ccls. or "396"/$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 19:43
S19	0	(damping with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer) and ("118"/$.ccls. or "396"/$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:38
S20	0	(dampening with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer) and ("118"/$.ccls. or "396"/$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:38
S21	0	(dampening with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:38
S22	10	(damping with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:38
S23	27	((buffer or buffering) with rod) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:39

S24	5	((buffer or buffering) with roller) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:39
S25	65	((damper or dampening or damping) with roller) and nozzle and (photoresist or developer) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/03/13 21:39

EAST Search History (Interference)

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3/15/10 11:12:31 AM
C:\Documents and Settings\gkoch1\My Documents\EAST\workspaces
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